

Electronic Packaging Material-Global Market Status and Trend Report 2013-2023

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Abstracts

Report Summary

Electronic Packaging Material-Global Market Status and Trend Report 2013-2023 offers a comprehensive analysis on Electronic Packaging Material industry, standing on the readers' perspective, delivering detailed market data and penetrating insights. No matter the client is industry insider, potential entrant or investor, the report will provides useful data and information. Key questions answered by this report include:

Worldwide and Regional Market Size of Electronic Packaging Material 2013-2017, and development forecast 2018-2023

Main manufacturers/suppliers of Electronic Packaging Material worldwide, with company and product introduction, position in the Electronic Packaging Material market Market status and development trend of Electronic Packaging Material by types and applications

Cost and profit status of Electronic Packaging Material, and marketing status Market growth drivers and challenges

The report segments the global Electronic Packaging Material market as:

Global Electronic Packaging Material Market: Regional Segment Analysis (Regional Production Volume, Consumption Volume, Revenue and Growth Rate 2013-2023):

North America

Europe

China

Japan



Rest APAC

Latin America

Global Electronic Packaging Material Market: Type Segment Analysis (Consumption Volume, Average Price, Revenue, Market Share and Trend 2013-2023):

Organic Substrates
Bonding Wires
Lead Frames
Ceramic Packages
Others

Global Electronic Packaging Material Market: Application Segment Analysis (Consumption Volume and Market Share 2013-2023; Downstream Customers and Market Analysis)

Semiconductor & IC

PCB

Others

Global Electronic Packaging Material Market: Manufacturers Segment Analysis (Company and Product introduction, Electronic Packaging Material Sales Volume, Revenue, Price and Gross Margin):

International Paper Company

Mitsubishi Chemical

Alent

Cookson

Hitachi Chemical

Kyocera Chemical

LG Chem

Sumitomo Chemical

BASF

Mitsui High-tec

Henkel

Toray

Tanaka

Indium Corporation

Atotech Deutschland GmbH



Eternal Chemical
Shinko Electric Industries
Dow

In a word, the report provides detailed statistics and analysis on the state of the industry; and is a valuable source of guidance and direction for companies and individuals interested in the market.



Contents

CHAPTER 1 OVERVIEW OF ELECTRONIC PACKAGING MATERIAL

- 1.1 Definition of Electronic Packaging Material in This Report
- 1.2 Commercial Types of Electronic Packaging Material
 - 1.2.1 Organic Substrates
 - 1.2.2 Bonding Wires
 - 1.2.3 Lead Frames
 - 1.2.4 Ceramic Packages
 - 1.2.5 Others
- 1.3 Downstream Application of Electronic Packaging Material
 - 1.3.1 Semiconductor & IC
 - 1.3.2 PCB
 - 1.3.3 Others
- 1.4 Development History of Electronic Packaging Material
- 1.5 Market Status and Trend of Electronic Packaging Material 2013-2023
- 1.5.1 Global Electronic Packaging Material Market Status and Trend 2013-2023
- 1.5.2 Regional Electronic Packaging Material Market Status and Trend 2013-2023

CHAPTER 2 GLOBAL MARKET STATUS AND FORECAST BY REGIONS

- 2.1 Market Development of Electronic Packaging Material 2013-2017
- 2.2 Production Market of Electronic Packaging Material by Regions
- 2.2.1 Production Volume of Electronic Packaging Material by Regions
- 2.2.2 Production Value of Electronic Packaging Material by Regions
- 2.3 Demand Market of Electronic Packaging Material by Regions
- 2.4 Production and Demand Status of Electronic Packaging Material by Regions
- 2.4.1 Production and Demand Status of Electronic Packaging Material by Regions 2013-2017
- 2.4.2 Import and Export Status of Electronic Packaging Material by Regions 2013-2017

CHAPTER 3 GLOBAL MARKET STATUS AND FORECAST BY TYPES

- 3.1 Production Volume of Electronic Packaging Material by Types
- 3.2 Production Value of Electronic Packaging Material by Types
- 3.3 Market Forecast of Electronic Packaging Material by Types



CHAPTER 4 GLOBAL MARKET STATUS AND FORECAST BY DOWNSTREAM INDUSTRY

- 4.1 Demand Volume of Electronic Packaging Material by Downstream Industry
- 4.2 Market Forecast of Electronic Packaging Material by Downstream Industry

CHAPTER 5 MARKET DRIVING FACTOR ANALYSIS OF ELECTRONIC PACKAGING MATERIAL

- 5.1 Global Economy Situation and Trend Overview
- 5.2 Electronic Packaging Material Downstream Industry Situation and Trend Overview

CHAPTER 6 ELECTRONIC PACKAGING MATERIAL MARKET COMPETITION STATUS BY MAJOR MANUFACTURERS

- 6.1 Production Volume of Electronic Packaging Material by Major Manufacturers
- 6.2 Production Value of Electronic Packaging Material by Major Manufacturers
- 6.3 Basic Information of Electronic Packaging Material by Major Manufacturers
- 6.3.1 Headquarters Location and Established Time of Electronic Packaging Material Major Manufacturer
- 6.3.2 Employees and Revenue Level of Electronic Packaging Material Major Manufacturer
- 6.4 Market Competition News and Trend
 - 6.4.1 Merger, Consolidation or Acquisition News
 - 6.4.2 Investment or Disinvestment News
 - 6.4.3 New Product Development and Launch

CHAPTER 7 ELECTRONIC PACKAGING MATERIAL MAJOR MANUFACTURERS INTRODUCTION AND MARKET DATA

- 7.1 International Paper Company
 - 7.1.1 Company profile
 - 7.1.2 Representative Electronic Packaging Material Product
- 7.1.3 Electronic Packaging Material Sales, Revenue, Price and Gross Margin of International Paper Company
- 7.2 Mitsubishi Chemical
 - 7.2.1 Company profile
 - 7.2.2 Representative Electronic Packaging Material Product
 - 7.2.3 Electronic Packaging Material Sales, Revenue, Price and Gross Margin of



Mitsubishi Chemical

- 7.3 Alent
 - 7.3.1 Company profile
 - 7.3.2 Representative Electronic Packaging Material Product
 - 7.3.3 Electronic Packaging Material Sales, Revenue, Price and Gross Margin of Alent
- 7.4 Cookson
 - 7.4.1 Company profile
 - 7.4.2 Representative Electronic Packaging Material Product
- 7.4.3 Electronic Packaging Material Sales, Revenue, Price and Gross Margin of Cookson
- 7.5 Hitachi Chemical
 - 7.5.1 Company profile
 - 7.5.2 Representative Electronic Packaging Material Product
- 7.5.3 Electronic Packaging Material Sales, Revenue, Price and Gross Margin of Hitachi Chemical
- 7.6 Kyocera Chemical
 - 7.6.1 Company profile
 - 7.6.2 Representative Electronic Packaging Material Product
- 7.6.3 Electronic Packaging Material Sales, Revenue, Price and Gross Margin of Kvocera Chemical
- 7.7 LG Chem
 - 7.7.1 Company profile
 - 7.7.2 Representative Electronic Packaging Material Product
- 7.7.3 Electronic Packaging Material Sales, Revenue, Price and Gross Margin of LG Chem
- 7.8 Sumitomo Chemical
 - 7.8.1 Company profile
 - 7.8.2 Representative Electronic Packaging Material Product
- 7.8.3 Electronic Packaging Material Sales, Revenue, Price and Gross Margin of Sumitomo Chemical
- **7.9 BASF**
 - 7.9.1 Company profile
 - 7.9.2 Representative Electronic Packaging Material Product
 - 7.9.3 Electronic Packaging Material Sales, Revenue, Price and Gross Margin of BASF
- 7.10 Mitsui High-tec
 - 7.10.1 Company profile
 - 7.10.2 Representative Electronic Packaging Material Product
- 7.10.3 Electronic Packaging Material Sales, Revenue, Price and Gross Margin of Mitsui High-tec



- 7.11 Henkel
 - 7.11.1 Company profile
 - 7.11.2 Representative Electronic Packaging Material Product
- 7.11.3 Electronic Packaging Material Sales, Revenue, Price and Gross Margin of Henkel
- 7.12 Toray
 - 7.12.1 Company profile
 - 7.12.2 Representative Electronic Packaging Material Product
- 7.12.3 Electronic Packaging Material Sales, Revenue, Price and Gross Margin of Toray
- 7.13 Tanaka
 - 7.13.1 Company profile
 - 7.13.2 Representative Electronic Packaging Material Product
- 7.13.3 Electronic Packaging Material Sales, Revenue, Price and Gross Margin of Tanaka
- 7.14 Indium Corporation
 - 7.14.1 Company profile
 - 7.14.2 Representative Electronic Packaging Material Product
- 7.14.3 Electronic Packaging Material Sales, Revenue, Price and Gross Margin of Indium Corporation
- 7.15 Atotech Deutschland GmbH
 - 7.15.1 Company profile
 - 7.15.2 Representative Electronic Packaging Material Product
- 7.15.3 Electronic Packaging Material Sales, Revenue, Price and Gross Margin of Atotech Deutschland GmbH
- 7.16 Eternal Chemical
- 7.17 Shinko Electric Industries
- 7.18 Dow

CHAPTER 8 UPSTREAM AND DOWNSTREAM MARKET ANALYSIS OF ELECTRONIC PACKAGING MATERIAL

- 8.1 Industry Chain of Electronic Packaging Material
- 8.2 Upstream Market and Representative Companies Analysis
- 8.3 Downstream Market and Representative Companies Analysis

CHAPTER 9 COST AND GROSS MARGIN ANALYSIS OF ELECTRONIC PACKAGING MATERIAL



- 9.1 Cost Structure Analysis of Electronic Packaging Material
- 9.2 Raw Materials Cost Analysis of Electronic Packaging Material
- 9.3 Labor Cost Analysis of Electronic Packaging Material
- 9.4 Manufacturing Expenses Analysis of Electronic Packaging Material

CHAPTER 10 MARKETING STATUS ANALYSIS OF ELECTRONIC PACKAGING MATERIAL

- 10.1 Marketing Channel
 - 10.1.1 Direct Marketing
 - 10.1.2 Indirect Marketing
 - 10.1.3 Marketing Channel Development Trend
- 10.2 Market Positioning
 - 10.2.1 Pricing Strategy
 - 10.2.2 Brand Strategy
 - 10.2.3 Target Client
- 10.3 Distributors/Traders List

CHAPTER 11 REPORT CONCLUSION

CHAPTER 12 RESEARCH METHODOLOGY AND REFERENCE

- 12.1 Methodology/Research Approach
 - 12.1.1 Research Programs/Design
 - 12.1.2 Market Size Estimation
 - 12.1.3 Market Breakdown and Data Triangulation
- 12.2 Data Source
 - 12.2.1 Secondary Sources
 - 12.2.2 Primary Sources
- 12.3 Reference



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